

Triacs

logic level

BT131 series

GENERAL DESCRIPTION

Passivated, sensitive gate triacs in a plastic envelope, intended for use in general purpose bidirectional switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

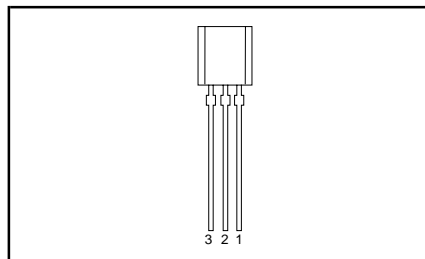
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | MAX. | UNIT |
|---------------------|--------------------------------------|------------|------------|------|
| V_{DRM} | Repetitive peak off-state voltages | 600 | 800 | V |
| $I_{\text{T(RMS)}}$ | RMS on-state current | 600 | 800 | A |
| I_{TSM} | Non-repetitive peak on-state current | 1 | 1 | A |
| | | 16 | 16 | A |

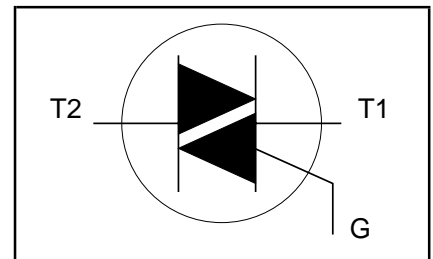
PINNING - TO92

| PIN | DESCRIPTION |
|-----|-----------------|
| 1 | main terminal 2 |
| 2 | gate |
| 3 | main terminal 1 |

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | | UNIT |
|---------------------|--|---|------|---------------------------------|--------------------|------------------|
| V_{DRM} | Repetitive peak off-state voltages | | - | -600 600 ¹ | -800 800 | V |
| $I_{\text{T(RMS)}}$ | RMS on-state current | full sine wave; $T_{\text{lead}} \leq 74^\circ\text{C}$ | - | 1 | | A |
| I_{TSM} | Non-repetitive peak on-state current | full sine wave; $T_j = 25^\circ\text{C}$ prior to surge | - | 16 | | A |
| | | $t = 20\text{ ms}$ | - | 17.6 | | A |
| | | $t = 16.7\text{ ms}$ | - | 1.28 | | A ² s |
| I^2t | I^2t for fusing | $t = 10\text{ ms}$ | - | | | |
| di_{T}/dt | Repetitive rate of rise of on-state current after triggering | $I_{\text{TM}} = 1.5\text{ A}$; $I_{\text{G}} = 0.2\text{ A}$; $di_{\text{G}}/dt = 0.2\text{ A}/\mu\text{s}$ | - | | | |
| | | T2+ G+ | - | 50 | | A/ μs |
| | | T2+ G- | - | 50 | | A/ μs |
| | | T2- G- | - | 50 | | A/ μs |
| | | T2- G+ | - | 10 | | A/ μs |
| I_{GM} | Peak gate current | | - | 2 | | A |
| P_{GM} | Peak gate power | | - | 5 | | W |
| $P_{\text{G(AV)}}$ | Average gate power | over any 20 ms period | - | 0.5 | | W |
| T_{stg} | Storage temperature | | -40 | 150 | | $^\circ\text{C}$ |
| T_j | Junction temperature | | - | 125 | | $^\circ\text{C}$ |

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 A/ μs .

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THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|--|--------------------------------|------|------|------|------|
| $R_{th\ j-lead}$ | Thermal resistance junction to lead | full cycle | - | - | 60 | K/W |
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | half cycle | - | - | 80 | K/W |
| | | pcb mounted; lead length = 4mm | - | 150 | - | K/W |

STATIC CHARACTERISTICS

$T_j = 25\ ^\circ\text{C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------|---------------------------|---|------|------|------|------|
| I_{GT} | Gate trigger current | $V_D = 12\ \text{V}$; $I_T = 0.1\ \text{A}$ | | | | |
| | | T2+ G+ | - | 0.4 | 3 | mA |
| | | T2+ G- | - | 1.3 | 3 | mA |
| | | T2- G- | - | 1.4 | 3 | mA |
| | | T2- G+ | - | 3.8 | 7 | mA |
| I_L | Latching current | $V_D = 12\ \text{V}$; $I_{GT} = 0.1\ \text{A}$ | | | | |
| | | T2+ G+ | - | 1.2 | 5 | mA |
| | | T2+ G- | - | 4.0 | 8 | mA |
| | | T2- G- | - | 1.0 | 5 | mA |
| | | T2- G+ | - | 2.5 | 8 | mA |
| I_H | Holding current | $V_D = 12\ \text{V}$; $I_{GT} = 0.1\ \text{A}$ | - | 1.3 | 5 | mA |
| V_T | On-state voltage | $I_T = 2.0\ \text{A}$ | - | 1.2 | 1.5 | V |
| V_{GT} | Gate trigger voltage | $V_D = 12\ \text{V}$; $I_T = 0.1\ \text{A}$ | - | 0.7 | 1.5 | V |
| | | $V_D = 400\ \text{V}$; $I_T = 0.1\ \text{A}$; $T_j = 125\ ^\circ\text{C}$ | 0.2 | 0.3 | - | V |
| I_D | Off-state leakage current | $V_D = V_{DRM(max)}$; $T_j = 125\ ^\circ\text{C}$ | - | 0.1 | 0.5 | mA |

DYNAMIC CHARACTERISTICS

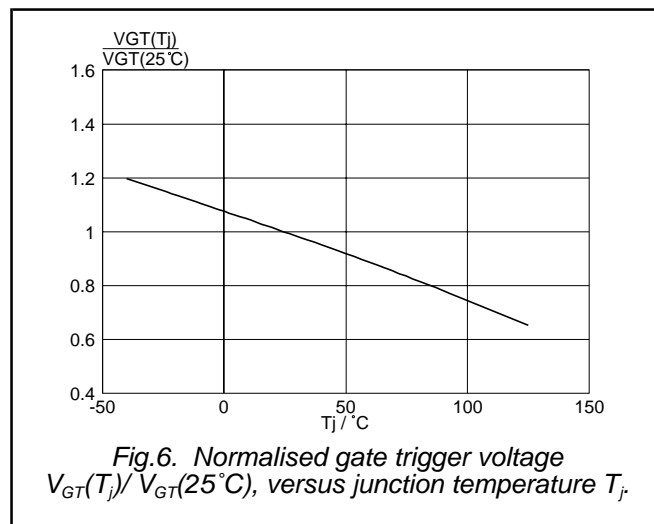
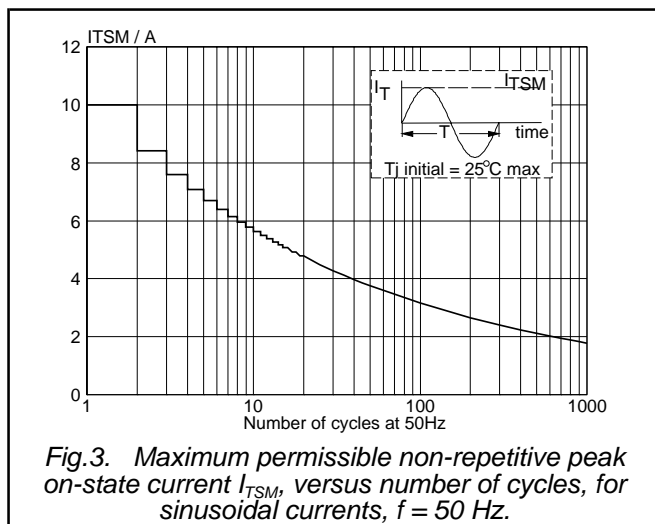
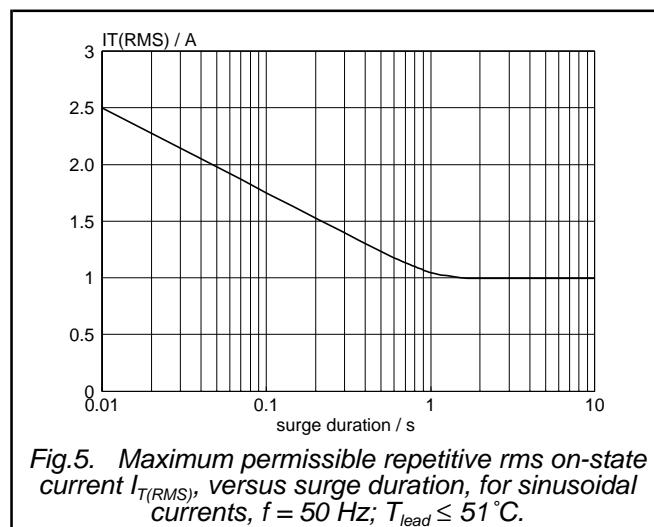
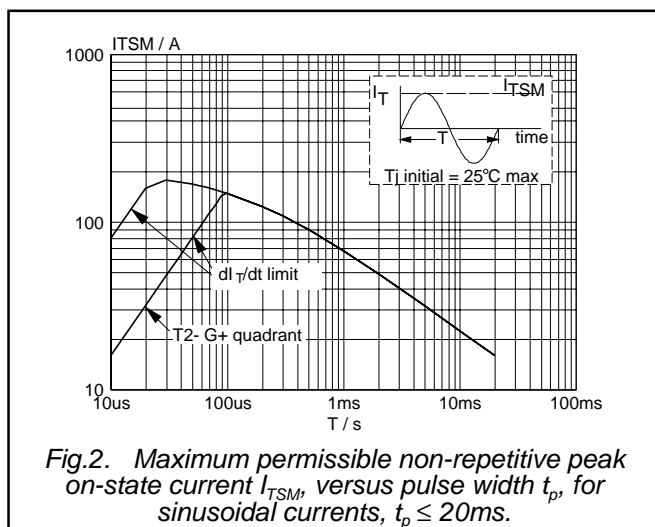
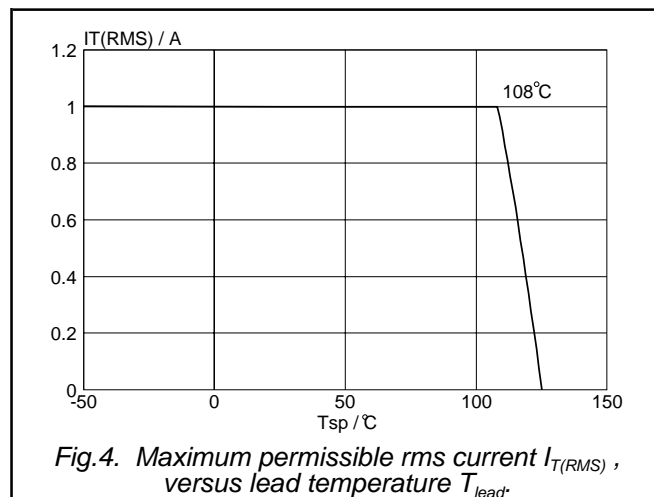
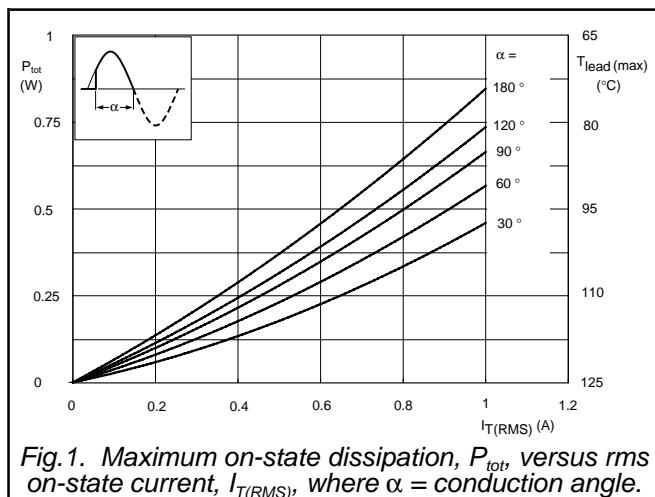
$T_j = 25\ ^\circ\text{C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|--|---|------|------|------|------------------|
| dV_D/dt | Critical rate of rise of off-state voltage | $V_{DM} = 67\% V_{DRM(max)}$; $T_j = 125\ ^\circ\text{C}$; exponential waveform; $R_{GK} = 1\ \text{k}\Omega$ | 5 | 15 | - | V/ μs |
| t_{gt} | Gate controlled turn-on time | $I_{TM} = 1.5\ \text{A}$; $V_D = V_{DRM(max)}$; $I_G = 0.1\ \text{A}$; $dI_G/dt = 5\ \text{A}/\mu\text{s}$ | - | 2 | - | μs |

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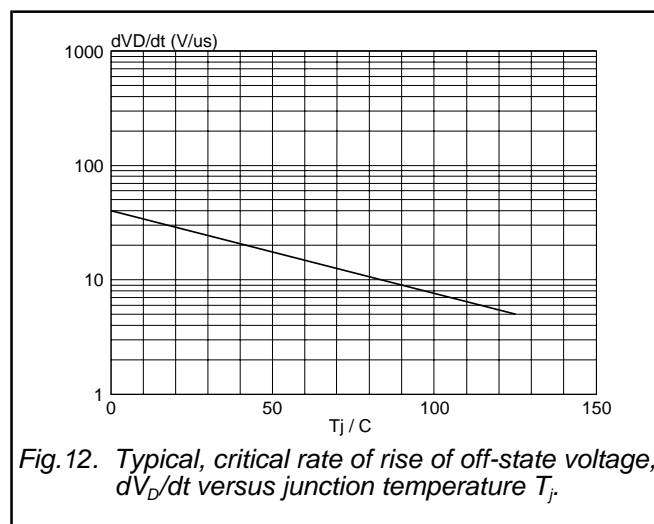
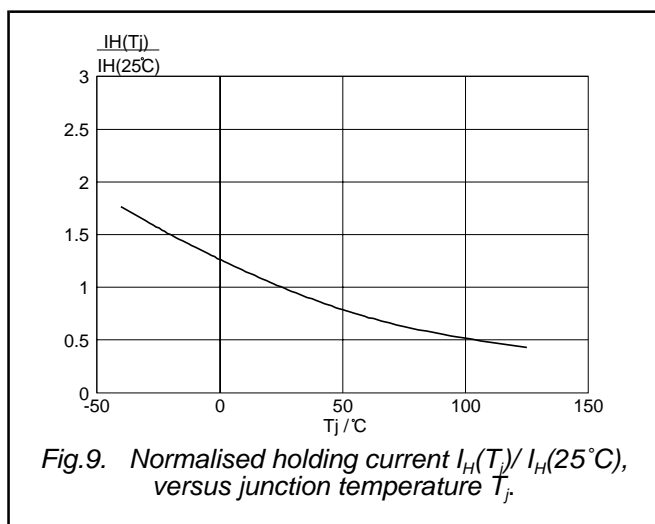
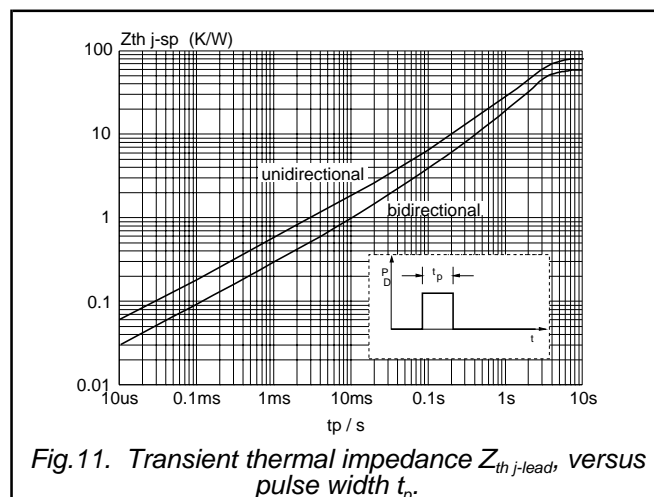
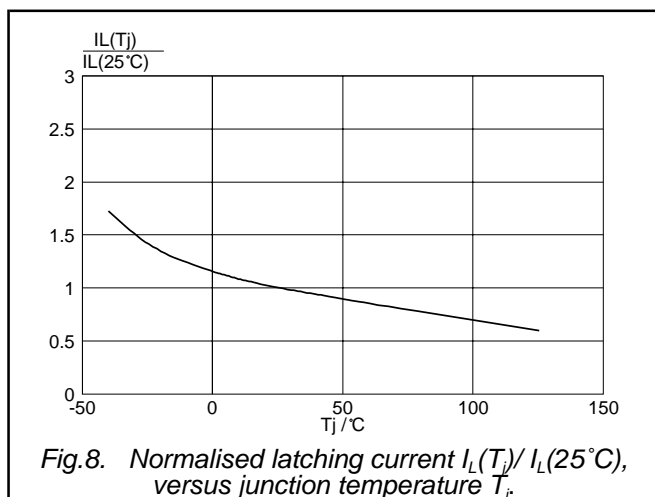
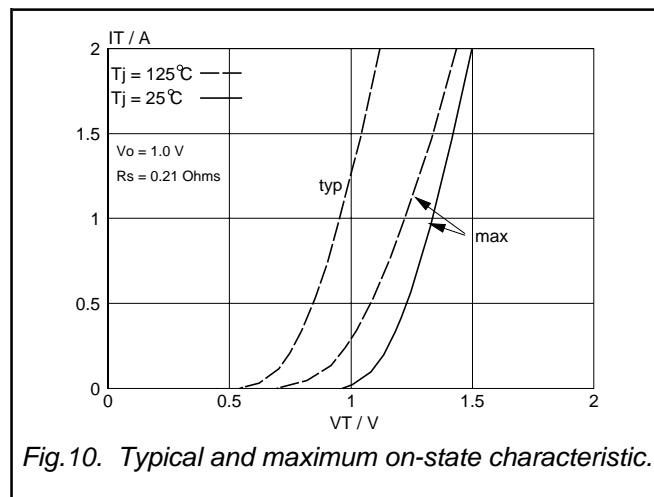
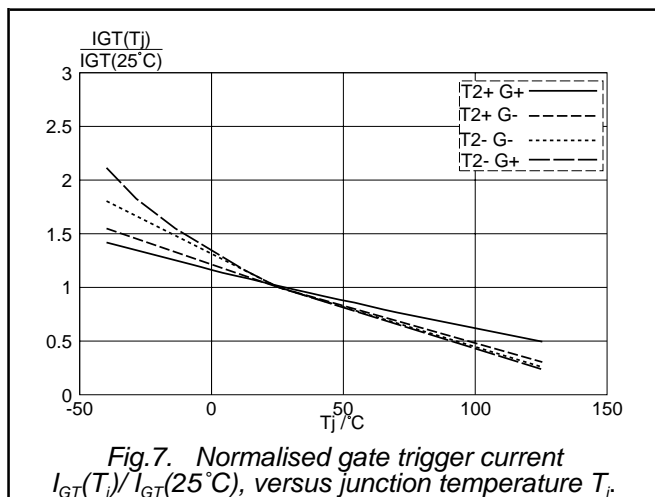
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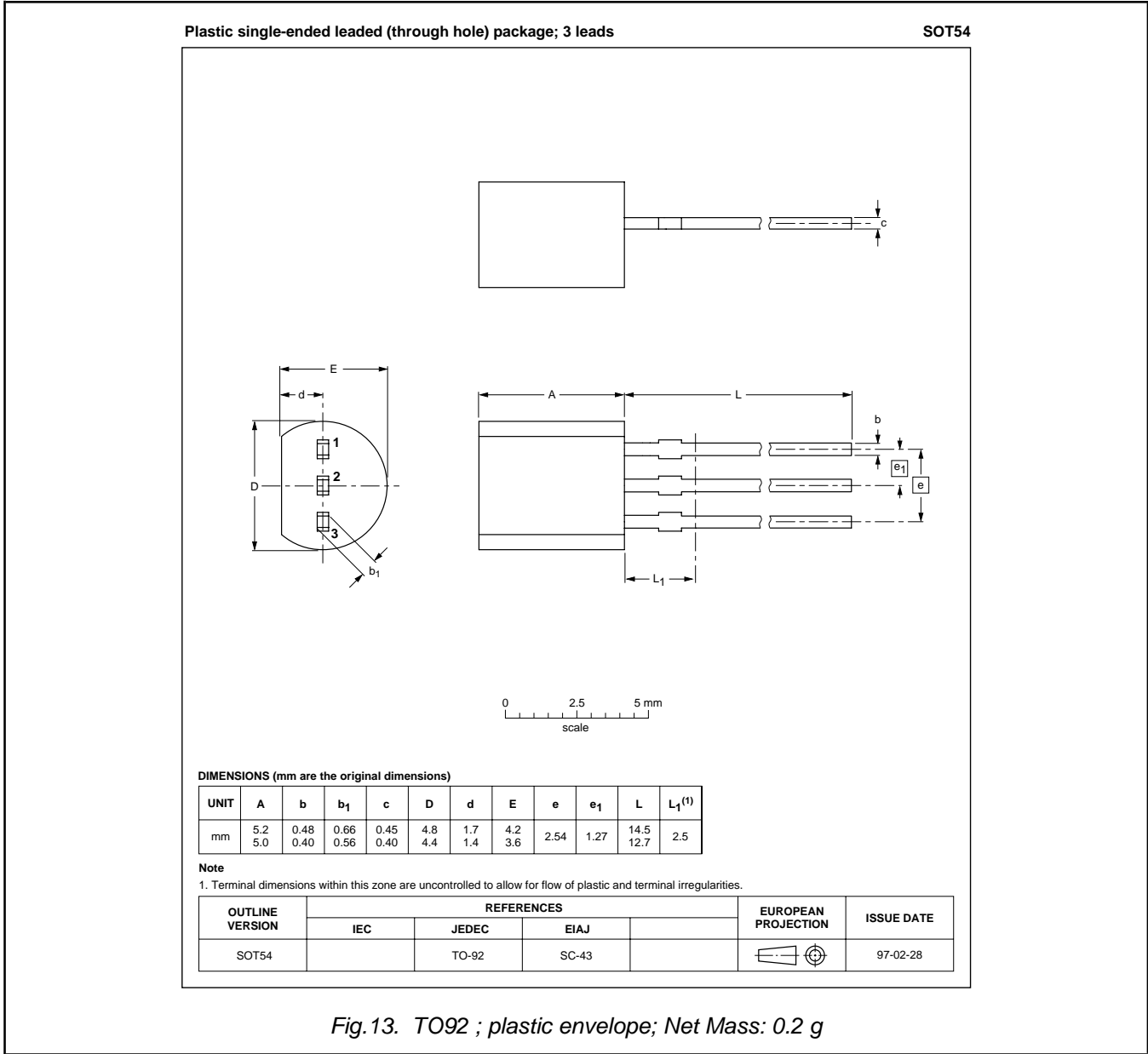
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MECHANICAL DATA



Notes

1. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

| DATA SHEET STATUS | | |
|--|-----------------------------|---|
| DATA SHEET STATUS ² | PRODUCT STATUS ³ | DEFINITIONS |
| Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice |
| Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product |
| Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A |
| Limiting values | | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | | |
| Application information | | |
| Where application information is given, it is advisory and does not form part of the specification. | | |
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2 Please consult the most recently issued datasheet before initiating or completing a design.

3 The product status of the device(s) described in this datasheet may have changed since this datasheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.